

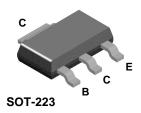
2N3906

MMBT3906

PZT3906







PNP General Purpose Amplifier

This device is designed for general purpose amplifier and switching applications at collector currents of 10 μA to 100 mA.

Absolute Maximum Ratings*

T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	-40	V
V _{CBO}	Collector-Base Voltage	-40	V
V _{EBO}	Emitter-Base Voltage	-5.0	V
I _C	Collector Current - Continuous	-200	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics T_A = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units	
		2N3906	*MMBT3906	**PZT3906	
P _D	Total Device Dissipation	625	350	1,000	mW
	Derate above 25°C	5.0	2.8	8.0	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3			°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	125	°C/W

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

¹⁾ These ratings are based on a maximum junction temperature of 150 degrees C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

^{**}Device mounted on FR-4 PCB 36 mm X 18 mm X 1.5 mm; mounting pad for the collector lead min. 6 cm².

(continued)

Electrical Characteristics	T _A = 25°C unless otherwise noted
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Symbol	Parameter Test Conditions		Min	Max	Units
OFF CHAP	RACTERISTICS				
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage*	$I_C = -1.0 \text{ mA}, I_B = 0$	-40		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = -10 \mu\text{A}, \ I_E = 0$	-40		V
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	$I_E = -10 \mu\text{A}, \ I_C = 0$	-5.0		V
I _{BL}	Base Cutoff Current	$V_{CE} = -30 \text{ V}, V_{BE} = -3.0 \text{ V}$		-50	nA
I _{CEX}	Collector Cutoff Current	$V_{CE} = -30 \text{ V}, V_{BE} = -3.0 \text{ V}$		-50	nA
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ON CHARACTERISTICS

h _{FE}	DC Current Gain *	$I_C = -0.1 \text{ mA}, V_{CE} = -1.0 \text{ V}$	60		
		$I_C = -1.0 \text{ mA}, V_{CE} = -1.0 \text{ V}$	80		
		$I_{\rm C} = -10 \text{ mA}, V_{\rm CE} = -1.0 \text{ V}$	100	300	
		$I_C = -50 \text{ mA}, V_{CE} = -1.0 \text{ V}$	60		
		$I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}$	30		
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = -10 \text{ mA}, I_B = -1.0 \text{ mA}$		-0.25	V
, ,		$I_C = -50 \text{ mA}, I_B = -5.0 \text{ mA}$		-0.4	V
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_C = -10 \text{ mA}, I_B = -1.0 \text{ mA}$	-0.65	-0.85	V
, ,		$I_C = -50 \text{ mA}, I_B = -5.0 \text{ mA}$		-0.95	V

SMALL SIGNAL CHARACTERISTICS

f⊤	Current Gain - Bandwidth Product	$I_C = -10 \text{ mA}, V_{CE} = -20 \text{ V},$ f = 100 MHz	250		MHz
C _{obo}	Output Capacitance	$V_{CB} = -5.0 \text{ V}, I_{E} = 0,$ f = 100 kHz		4.5	pF
C _{ibo}	Input Capacitance	$V_{EB} = -0.5 \text{ V}, I_{C} = 0,$ f = 100 kHz		10.0	pF
NF	Noise Figure	$I_C = -100 \mu\text{A}, V_{CE} = -5.0 \text{V},$ $R_S = 1.0 \text{k}\Omega$ f=10 Hz to 15.7 kHz		4.0	dB

SWITCHING CHARACTERISTICS

t _d	Delay Time	$V_{CC} = -3.0 \text{ V}, V_{BE} = -0.5 \text{ V},$	35	ns
t _r	Rise Time	$I_C = -10 \text{ mA}, I_{B1} = -1.0 \text{ mA}$	35	ns
ts	Storage Time	$V_{CC} = -3.0 \text{ V}, I_{C} = -10 \text{ mA}$	225	ns
t _f	Fall Time	$I_{B1} = I_{B2} = -1.0 \text{ mA}$	75	ns

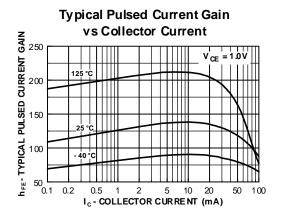
^{*}Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%

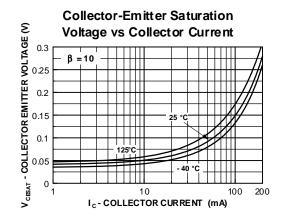
Spice Model

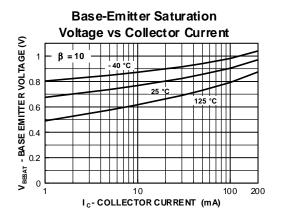
PNP (Is=1.41f Xti=3 Eg=1.11 Vaf=18.7 Bf=180.7 Ne=1.5 Ise=0 Ikf=80m Xtb=1.5 Br=4.977 Nc=2 Isc=0 Ikr=0 Rc=2.5 Cjc=9.728p Mjc=.5776 Vjc=.75 Fc=.5 Cje=8.063p Mje=.3677 Vje=.75 Tr=33.42n Tf=179.3p Itf=.4 Vtf=4 Xtf=6 Rb=10)

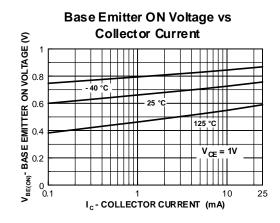
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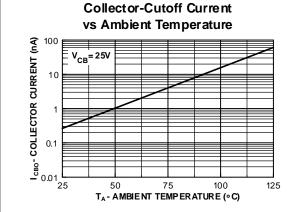
Typical Characteristics

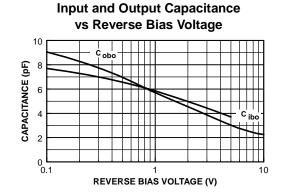








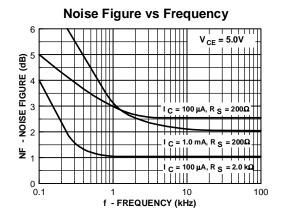


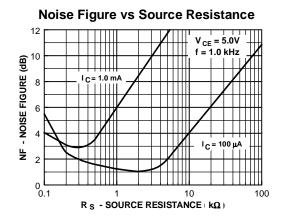


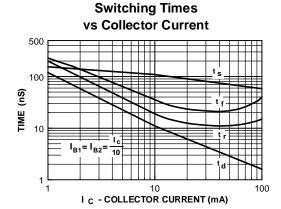
Common-Base Open Circuit

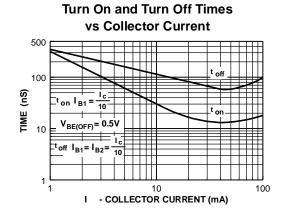
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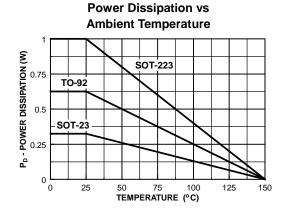
Typical Characteristics (continued)





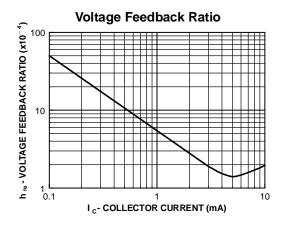


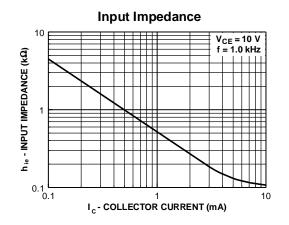


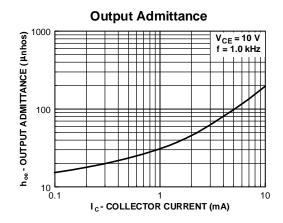


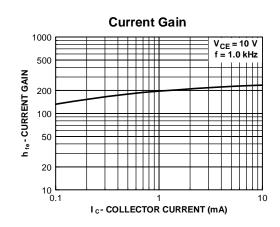
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Typical Characteristics (continued)









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